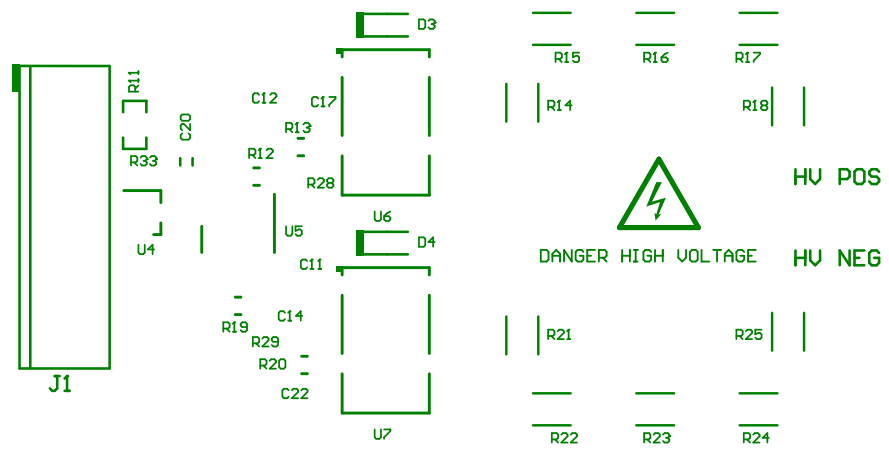
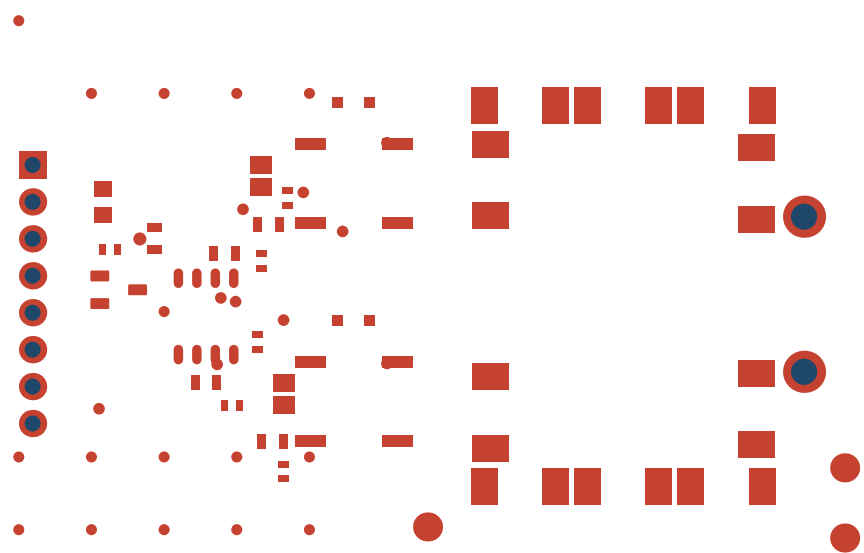


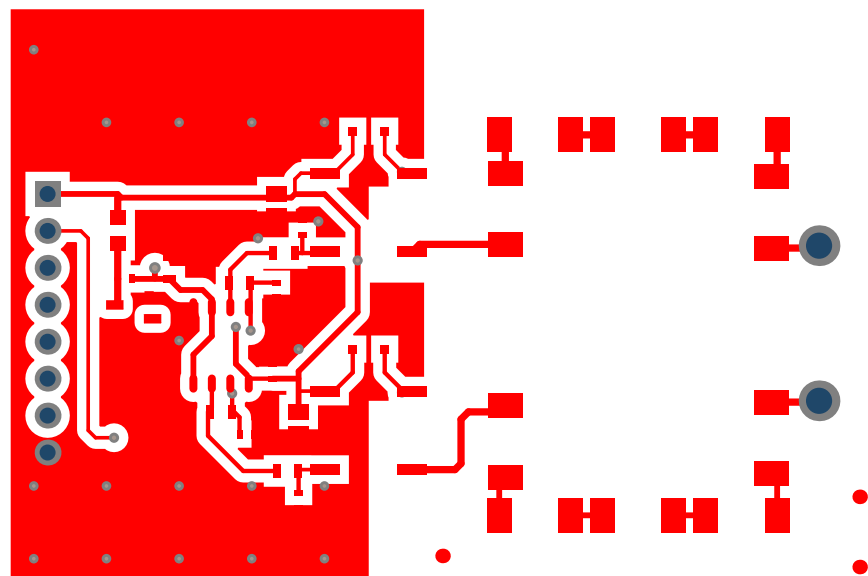
TIDA-01513E1-



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 4/19/2018 11:17:00 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 4/19/2018 11:17:00 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: TIDA-01513

REV: E1

SUN REV: Not In VersionControl

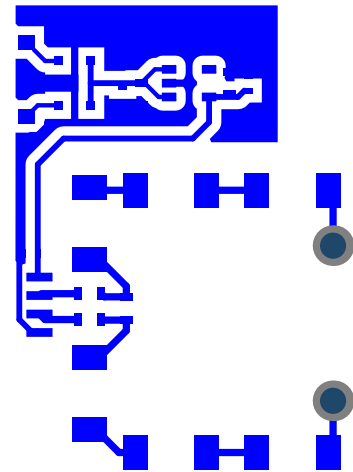
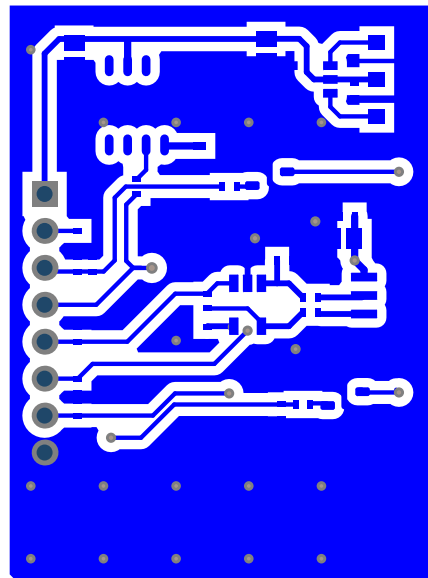
LAYER NAME = Top Layer

TID #: N/A

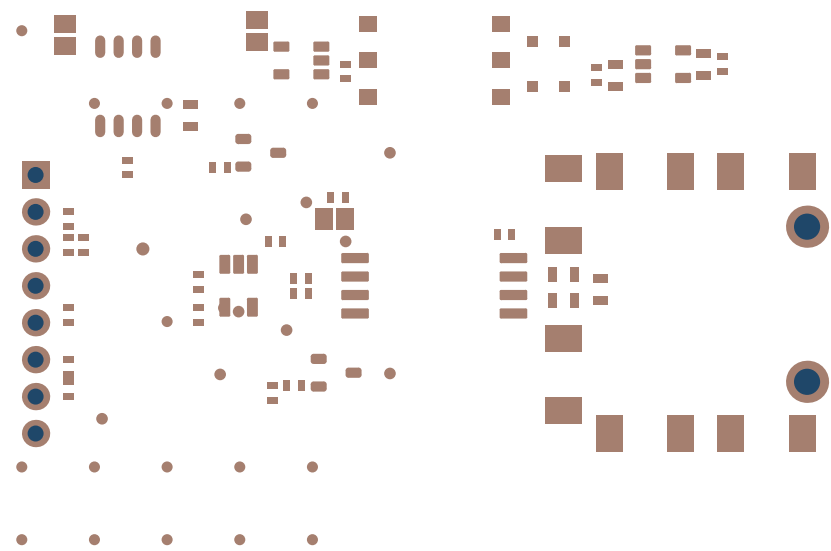
PLOT NAME = Top Layer

GENERATED : 4/19/2018 11:17:01 AM

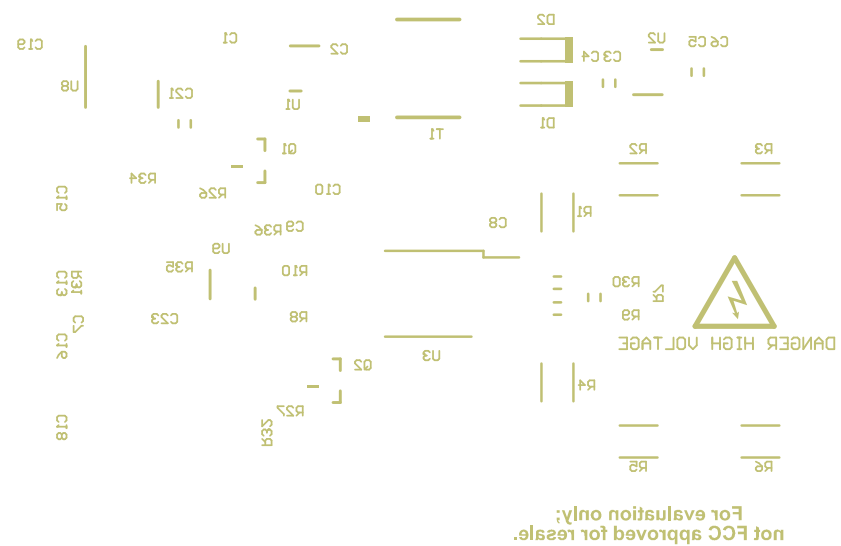
TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 4/19/2018 11:17:01 AM	TEXAS INSTRUMENTS	

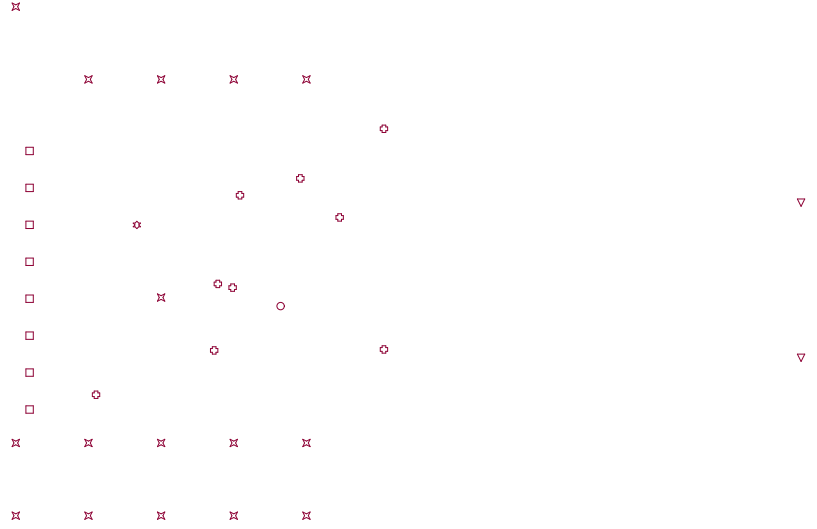


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/19/2018 11:17:01 AM	TEXAS INSTRUMENTS	

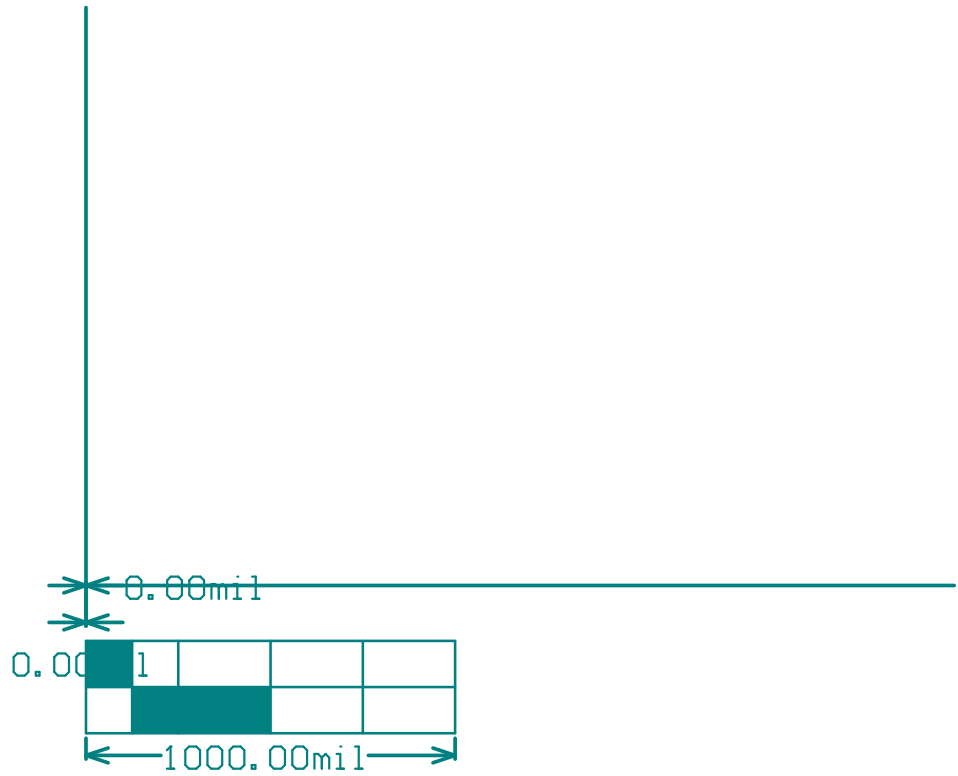


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 4/19/2018 11:17:01 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
○	1	9.84mil (0.250mm)	PTH	Round	Top Layer - Bottom Layer	
✕	16	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	9	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	
☆	1	15.75mil (0.400mm)	PTH	Round	Top Layer - Bottom Layer	
□	8	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
▽	2	70.87mil (1.800mm)	PTH	Round	Top Layer - Bottom Layer	
	37 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 4/19/2018 11:17:01 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01513	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 4/19/2018 11:17:01 AM	TEXAS INSTRUMENTS	

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